

Maintaining and Facilitating Component Manufacturing Without Ownership of Process or Test Equipment

Presenter:

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ES Components – Bio



ES Components, established in 1981, supports mission-critical defense and aerospace programs by delivering hard-to-find and high-reliability electronic components. With vertically integrated capabilities—from die access to hermetic packaging and screening—we help customers reduce supply-chain risk and sustain long-life systems. The product manufacturing team is led by Don Larson, who brings over 40 years of semiconductor industry experience.



Agenda

- **Background & Motivation**
- **Transition to a Distributed Manufacturing Model**
- **Key Engineering & Operational Elements**
- **Process Controls & Documentation**
- **Integration Process**
- **Lessons Learned**
- **Conclusion & Q&A**
- **Case Studies**



Background

- **2017 acquisition of Vishay Siliconix hermetic JFET, MOSFET & Analog Switch product lines**
- **Transition from die centric supplier → full manufacturer**
- **Need for a manufacturing model without owned process/test equipment**

Strategic Manufacturing Model



- **Fully distributed manufacturing ecosystem**
- **Use of qualified external:**
 - **Wafer fab partners**
 - **Assembly & packaging houses**
 - **Electrical/environmental test labs**

Strategic Manufacturing Model (Con't)



- **ES Components Audits:**
 - **Process flows**
 - **Documentation and configuration**
 - **Quality, reliability, and program compliance**

Key Engineering Considerations



- **Die level material inventory structuring**
- **End to end process flow definition**
- **Build traveler and documentation governance**
- **Configuration management and revision control**
- **Multi site correlation & verification requirements**



Process Control Methodology

- **Electrical parameter baseline characterization**
- **Stability trend monitoring across suppliers**
- **Yield and failure-mode tracking**
- **Subcontractor qualification and ongoing surveillance**
- **Process change assessment (PCN) & risk mitigation**



Documentation System

- **Manufacturing routers/travelers**
- **Controlled test flows & screening sequences**
- **Controlled build standards and drawing packages**
- **Closed-loop corrective action**



Customer Alignment

- **Transparent communication with aerospace/defense customers**
- **Traceability assurance**
- **Build-to-print accuracy for legacy hermetic devices**
- **Supporting DMSMS-driven requirements**

Integration Process – Pre Transition



- **Setup transition team with all involved parties**
- **Coordinate with compliance agencies to ensure conformance to requirements**
- **Manage traceability of inventory**
- **Setup Inventory and Process control systems**
- **Identify and audit certified subcontractors**

Integration Process – Post Transition



- **Integrate inventory into system**
- **Setup internal product management team**
- **Set up audit schedule with affected agencies/customers**
- **Qualify subcontracting facilities**



Risk Mitigation Framework

- **Multiple source and alternate process validation**
- **FMEA driven oversight**
- **Data-driven control: SPC, guard-banding, trend charts**
- **Rapid problem-resolution loops with subcontractors**
- **Maintain systematic Customer support**



Lessons Learned

- **Distributed manufacturing can meet MIL level reliability**
- **Strong documentation control is mandatory**
- **Partner alignment is continuous—not one-time**
- **Early correlation prevents downstream failures**
- **External equipment does not reduce internal engineering responsibility**



Conclusion

- **ES Components successfully manufactures high reliability products without owning process/test equipment**
- **Engineering discipline and documentation control are essential**
- **Model is scalable for mixed-technology, multi-partner environments, allowing for flexibility**
- **Useful template for organizations evaluating outsourced manufacturing strategies**

Case Study 1: Die From Inventory



- **Core Memory die from existing legacy inventory**
- **Processed per customer supplied SCD**
- **Assembly using MIL-PRF-38535 certified subcontractor**
- **Test using customer recommended ESC audited subcontractor**

Case Study 2: Customer Supplied Die



- **Customer supplied legacy die to support 8-line to 1-line data selector/multiplexer**
- **Created SCD referencing Generic Datasheet and Class S Mil Flow**
- **Assembly/Test using MIL-PRF-38535 certified subcontractor**



Questions



Acronyms

- **DLA – Defense Logistics Agency**
- **DMSMS – Diminishing Manufacturing Sources and Material Shortages**
- **PCN – Product (Process) Change Notice**
- **SCD – Source Control Drawing**
- **SPC – Statistical Process Control**